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Part Number: 07;	36421000	
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	<u>/ Backplane Connector System</u>	
Description: HDN	I Board-to-Board Backplane Header, Vertical, Press-Fit, Open End, 144	4 Circuits
-		- Sillion in
Documents:		
<u>3D Model</u>	Product Specification PS-73670-9999-001	
Drawing (PDF)	Packaging Specification PK-70873-0818-0	
<u>3D Model (PDF)</u>	RoHS Certificate of Compliance (PDF)	
Agency Certification		Series image - Reference only
CSA	LR19980	
UL	E29179	EU ELV
		Not Relevant
General		
Product Family	Backplane Connectors	EU RoHS China RoHS
Series	73642	Compliant
Application	Backplane	REACH SVHC
Comments	Standard Press-Fit	Not Contained Per -
Component Type	PCB Header	D(2021)4569-DC (8
Overview	HDM Backplane Connector System	July 2021)
Product Name	HDM	Halogen-Free
UPC	800754345118	<u>Status</u>
Dhusiaal		Low-Halogen
Physical		For more information, please visit Contact
Circuits (Loaded)	144	
Circuits (maximum)	144	China ROHS Green Image
Color - Resin	Black, Natural	ELV Not Relevant
Durability (mating cycles ma		RoHS Phthalates Not Contained
First Mate / Last Break	No	
Flammability	94V-0	
Guide to Mating Part	No	Search Parts in this Series
Keying to Mating Part	None	73642 Series
Material - Metal	Phosphor Bronze	
Material - Plating Mating	Gold	
Material - Plating Termination		Mates With
Material - Resin	High Temperature Thermoplastic	73632 HDM+ Board-to-Board Daughter
Net Weight	6.705/g	Receptacle. <u>73780</u> HDM Board-to-Boar
Number of Columns	24	Daughtercard Receptacle
Number of Pairs	Open Pin Field	
Number of Rows	6	Application Tooling FAQ
Orientation	Vertical	Tooling specifications and manuals are
PC Tail Length	3.50mm	found by selecting the products below.
PCB Locator	No	Crimp Height Specifications are then
PCB Retention	None	contained in the Application Tooling
PCB Thickness - Recomme		Specification document.
Packaging Type	Tube	Global
Pitch - Mating Interface	2.00mm	Description Product #
Pitch - Termination Interface		Extraction Tool <u>621001000</u>
Plating min - Mating	0.762µm	1
Plating min - Termination	0.051µm	
Polarized to PCB	No	
Stackable	Yes	
Surface Mount Compatible		
Temperature Range - Opera	-	
Termination Interface: Style	Through Hole - Compliant Pin	

Electrical	
Current - Maximum per Contact	1.0A
Data Rate	1.0 Gbps
Real Signals (per 25mm)	75
Shielded	No
Voltage - Maximum	250V AC
Solder Process Data Lead-freeProcess Capability	N/A
Material Info	
Reference - Drawing Numbers	
Packaging Specification	PK-70873-0818
Product Specification	PS-73670-000

Product Specification Sales Drawing PK-70873-0818-001 PS-73670-9999-001 SDA-73642-XXXX-001, SDA-73642-XXXX-002

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